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(54) Title: GRIPPER HEAD, DEVICE, AND METHOD FOR HANDLING AND VARYING THE SPACING OF ELECTRONIC COMPONENTS ARRANGED IN A MATRIX STRUCTURE

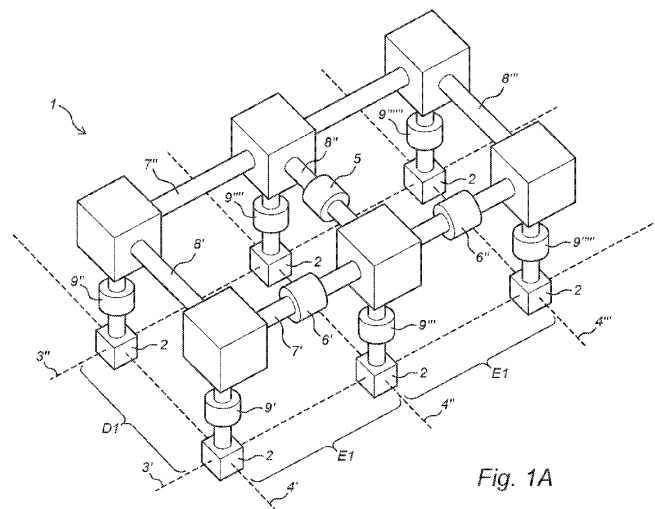


Fig. 1A

(57) Abstract: The invention relates to a gripper head for handling and varying the spacing of electronic components arranged in a matrix structure, comprising: multiple grippers arranged in a matrix orientation of X rows and Y columns of grippers; and individually controllable displacement drives acting between adjoining gripper rows and between adjoining gripper columns. The invention also relates to a device and a method for handling and varying the spacing of electronic components.

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